

MOSFET - P-Channel, QFET

-60 V, -17 A, 120 mΩ

FQP17P06

Description

This P-Channel enhancement mode power MOSFET is produced using **onsemi**'s proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

- -17 A, -60 V, $R_{DS(on)} = 120 \text{ m}\Omega$ (Max.) @ $V_{GS} = -10 \text{ V}$, $I_D = -8.5 \text{ A}$
- Low Gate Charge (Typ. 21 nC)
- Low Crss (Typ. 80 pF)
- 100% Avalanche Tested
- 175°C Maximum Junction Temperature Rating
- This is a Pb-Free and Halide Free Device

ABSOLUTE MAXIMUM RATINGS

(T_C = 25°C unless otherwise specified)

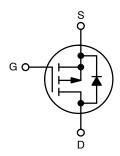
Symbol		Parameter	Value	Unit
V _{DSS}	Drain-Source V	-60	V	
I _D	Drain Current	Prain Current – Continuous (T _C = 25°C)		Α
		- Continuous (T _C = 100°C)	-12	Α
I _{DM}	Drain Current	- Pulsed (Note 1)	-68	Α
V_{GSS}	Gate-Source Vo	oltage	±25	V
E _{AS}	Single Pulsed A	300	mJ	
I _{AR}	Avalanche Curre	-17	Α	
E _{AR}	Repetitive Avala	7.9	mJ	
dv/dt	Peak Diode Red	covery dv/dt (Note 3)	-7.0	V/ns
P_{D}	Power	(T _C = 25°C)	79	W
	Dissipation	- Derate above 25°C	0.53	W/°C
T _J , T _{STG}	Operating and S	–55 to +175	°C	
TL	Maximum Lead Purposes, 1/8" f	300	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

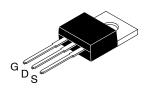
1

- 1. Repetitive Rating : Pulse width limited by maximum junction temperature
- 2. L = 1.2 mH, I_{AS} = -17 A, V_{DD} = -25 V, R_G = 25 Ω , Starting T_J = 25°C 3. $I_{SD} \le -17$ A, di/dt ≤ 300 A/ μ s, $V_{DD} \le BV_{DSS}$, Starting T_J = 25°C

V _{DSS}	R _{DS(on)} MAX	I _D MAX	
-60 V	120 mΩ @ –10 V	–17 A	

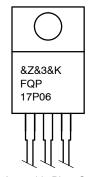


P-Channel MOSFET



TO-220-3LD CASE 340AT

MARKING DIAGRAM



&Z = Assembly Plant Code = 3-Digit Plant Code &3

&K = 2-Digits Lot Run Traceability Code

FQP17P06 = Specific Device Code

ORDERING INFORMATION

Device	Package	Shipping
FQP17P06	TO-220-3LD	1000 Units / Tube

THERMAL CHARACTERISTICS

Symbol	Characteristic	Value	Unit
$R_{ heta JC}$	Thermal Resistance, Junction-to-Case, Max.	1.9	°C/W
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink, Typ.	0.5	°C/W
$R_{ heta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	°C/W

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Condition	Min	Тур	Max	Unit
FF CHAR	ACTERISTICS			-	<u>-</u>	-
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V, } I_D = -250 \mu\text{A}$	-60	-	_	V
ΔBV_{DSS}	Breakdown Voltage Temperature Coefficient	I_D = -250 μ A, Referenced to 25°C	-	-0.06	-	V/°C
ΔT_{J}						
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = -60 V, V _{GS} = 0 V	-	-	-1	μΑ
		V _{DS} = -48 V, T _C = 150°C	-	-	-10	μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	$V_{GS} = -25 \text{ V}, V_{DS} = 0 \text{ V}$	-	-	-100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = 25 V, V _{DS} = 0 V	-	-	100	nA
ON CHARA	ACTERISTICS					
V _{GS(th})	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -250 \mu A$	-2.0	-	-4.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	$V_{GS} = -10 \text{ V}, I_D = -8.5 \text{ A}$	-	0.094	0.12	Ω
9 _{FS}	Forward Transconductance	$V_{DS} = -30 \text{ V}, I_D = -8.5 \text{ A}$	-	9.3	_	S
YNAMIC	CHARACTERISTICS	•				
C _{iss}	Input Capacitance	$V_{DS} = -25 \text{ V}, V_{GS} = 0 \text{ V}, f = 1.0 \text{ MHz}$	-	690	900	pF
C _{oss}	Output Capacitance		-	325	420	pF
C _{rss}	Reverse Transfer Capacitance		-	80	105	pF
WITCHIN	G CHARACTERISTICS					
t _{d(on)}	Turn-On Delay Time	$V_{DD} = -30 \text{ V}, I_D = -8.5 \text{ A}, R_G = 25 \Omega$	-	13	35	ns
t _r	Turn-On Rise Time	(Note 4)	-	100	210	ns
t _{d(off)}	Turn-Off Delay Time	7	-	22	55	ns
t _f	Turn-Off Fall Time	7	-	60	130	ns
Qg	Total Gate Charge	$V_{DS} = -48 \text{ V}, I_{D} = -17 \text{ A}, V_{GS} = -10 \text{ V}$	-	21	27	nC
Q _{gs}	Gate-Source Charge	(Note 4)	-	4.2	-	nC
Q _{gd}	Gate-Drain Charge	7	-	10	_	nC
RAIN-SC	DURCE DIODE CHARACTERISTICS AND MAX	IMUM RATING				
I _S	Maximum Continuous Drain-Source Diode For	ward Current	-	-	-17	Α
I _{SM}	Maximum Pulsed Drain-Source Diode Forward	d Current	-	-	-68	Α
V_{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_{S} = -17 \text{ A}$	_	-	-4.0	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 \text{ V, } I_{S} = -17 \text{ A,}$ $dI_{F}/dt = 100 \text{ A/}\mu\text{s}$	-	92	-	ns
Q _{rr}	Reverse Recovery Charge	dI _F / at = 100 A/μs	_	0.32	_	μС

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Essentially independent of operating temperature

TYPICAL CHARACTERISTICS

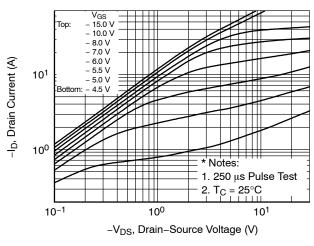


Figure 1. On-Region Characteristics

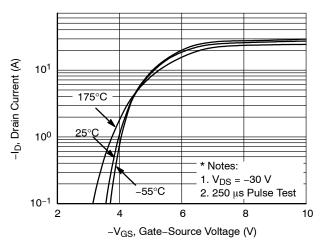


Figure 2. Transfer Characteristics

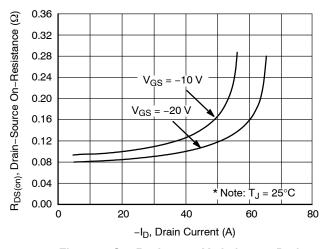


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

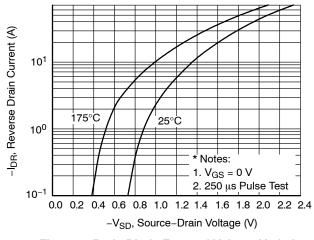


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

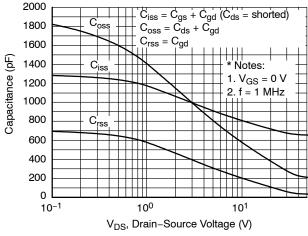


Figure 5. Capacitance Characteristics

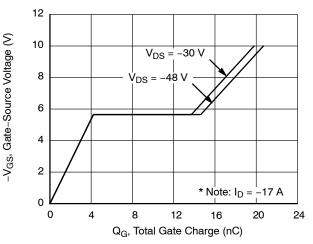
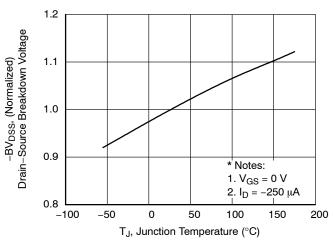


Figure 6. Gate Charge Characteristics

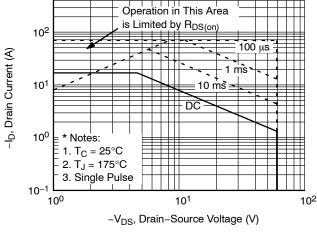
TYPICAL CHARACTERISTICS (continued)



2.5 Drain-Source On-Resistance 2.0 R_{DS(ON)}, (normalized) 1.5 1.0 0.5 * Notes: 1. $V_{GS} = -10 \text{ V}$ 2. $I_D = -8.5 \text{ A}$ 100 -100 -50 0 50 150 200 T_J, Junction Temperature (°C)

Figure 7. Breakdown Voltage Variation vs. Temperature

Figure 8. On–Resistance Variation vs. Temperature



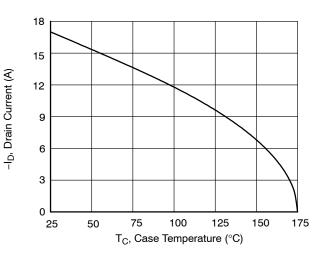


Figure 9. Maximum Safe Operating Area

Figure 10. Maximum Drain Current vs. Case Temperature

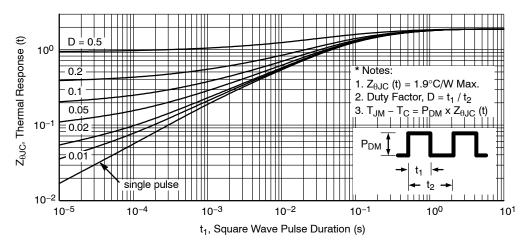


Figure 11. Transient Thermal Response Curve

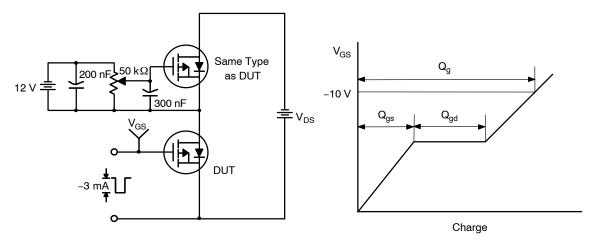


Figure 12. Gate Charge Test Circuit & Waveform

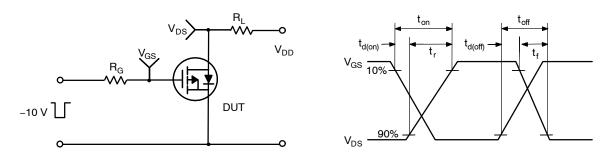


Figure 13. Resistive Switching Test Circuit & Waveforms

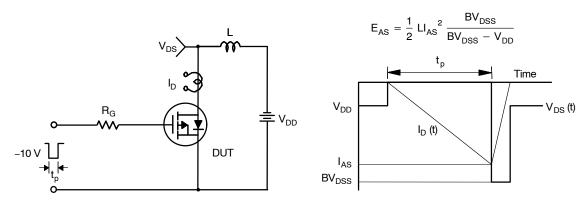
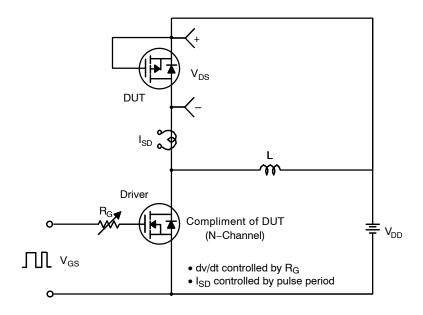


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms



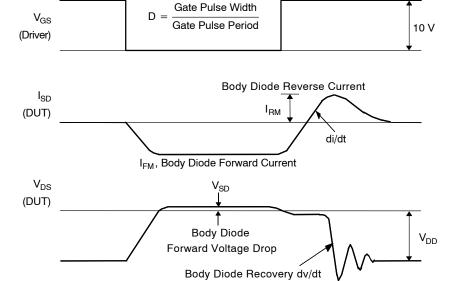
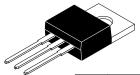


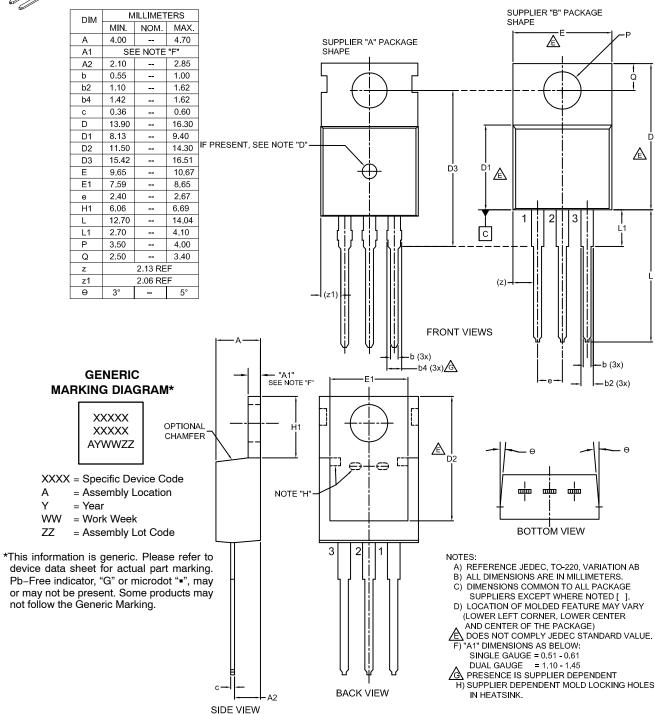
Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms





TO-220-3LD CASE 340AT ISSUE B

DATE 08 AUG 2022



DOCUMENT NUMBER:	98AON13818G	Electronic versions are uncontrolled except when accessed directly from the Document Repository Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
DESCRIPTION:	TO-220-3LD		PAGE 1 OF 1	

onsemi and ONSEMI are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

onsemi, Onsemi, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. Onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA class 3 medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

 $\textbf{Technical Library:} \ \underline{www.onsemi.com/design/resources/technical-documentation}$

onsemi Website: www.onsemi.com

ONLINE SUPPORT: www.onsemi.com/support

For additional information, please contact your local Sales Representative at

www.onsemi.com/support/sales